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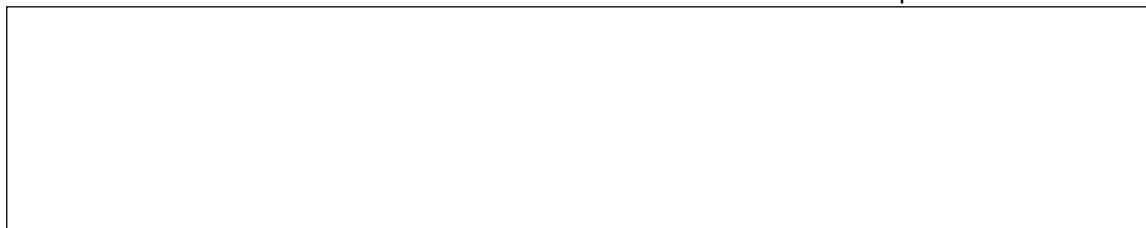
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REVISION DESCRIPTION LIST

M3776AM8A/MCA/MFA-XXXGP

| Rev. No. | Revision Description | Rev. date |
|----------|---------------------------|-----------|
| 1.00 | First Edition of PDF File | 0217 |
| | | |